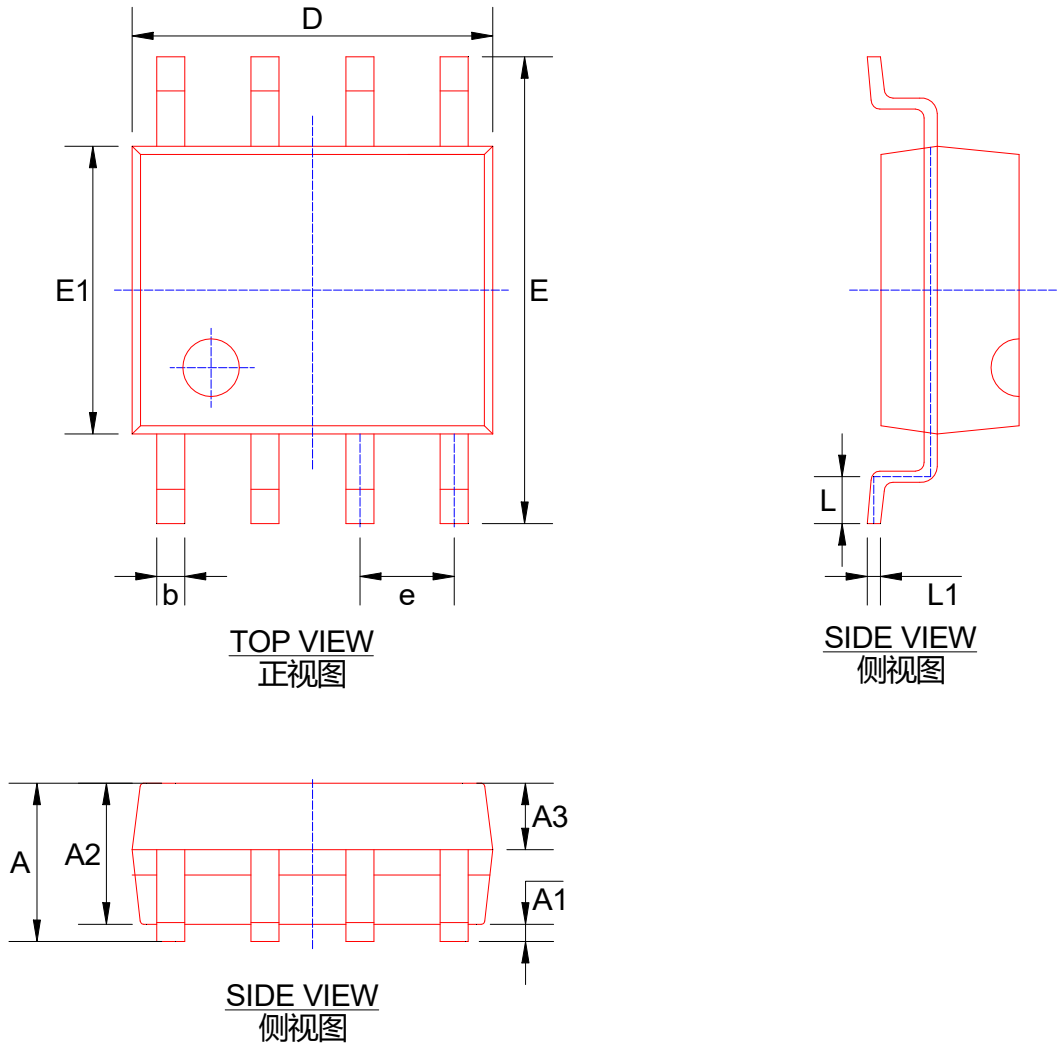


	深圳市锐骏半导体有限公司 ShenZhen Ruichips Semiconductor CO.,LTD	编号	RU-001-SOP8-A-001
	封装外形尺寸（POD）规范	版本	A/2
		页次	9

SOP8



- NOTE:
- 1: ALL UNITS ARE IN MILLIMETER.
 - 2: EJECTOR PIN MARK POSITION MAY VARY FROM DIFFERENT MOLD.
 - 3: ALL DIMENSIONS REFER TO JEDEC.DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.450	1.550	1.650	0.057	0.061	0.065
A1	0.050	—	0.250	0.002	—	0.010
A2	1.400	1.450	1.500	0.055	0.057	0.059
A3	0.550	0.600	0.650	0.022	0.024	0.026
b	0.380	—	0.510	0.015	—	0.020
e	1.270 BSC			0.050 BSC		
D	4.800	4.900	5.000	0.189	0.193	0.197
E	5.800	6.000	6.200	0.228	0.236	0.244
E1	3.800	3.900	4.000	0.150	0.154	0.157
L	0.450	0.600	0.750	0.018	0.024	0.030
L1	0.25BSC			0.010 BSC		